

NPN SILICON LOW POWER TRANSISTOR

Qualified per MIL-PRF-19500/376

Devices

2N2484

Qualified Level

**JANTX
JANTXV**

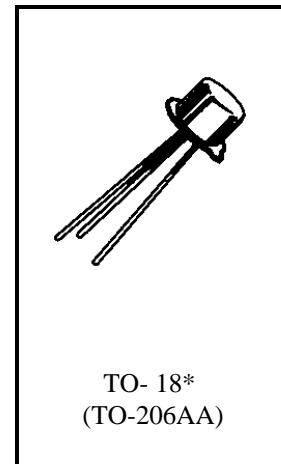
MAXIMUM RATINGS

Ratings	Symbol	2N2484	Unit
Collector-Emitter Voltage	V_{CEO}	60	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	6.0	Vdc
Collector Current	I_C	50	mAdc
Total Power Dissipation	P_T	@ $T_A = +25^{\circ}C^{(1)}$	360
		@ $T_C = +25^{\circ}C^{(2)}$	1.2
Operating & Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200	$^{\circ}C$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max.	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	146	$^{\circ}C/W$

- 1) Derate linearly 2.06 mW/ $^{\circ}C$ above $T_A = +25^{\circ}C$
 2) Derate linearly 6.85 mW/ $^{\circ}C$ above $T_C = +25^{\circ}C$



*See appendix A for package outline

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristics	Symbol	Min.	Max.	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Current $I_C = 10$ mAdc	$V_{(BR)CEO}$	60		Vdc
Collector-Emitter Cutoff Current $V_{CE} = 45$ Vdc	I_{CES}		5.0	η Adc
Collector-Base Cutoff Current $V_{CB} = 45$ Vdc $V_{CB} = 60$ Vdc	I_{CBO}		5.0	η Adc
			10	μ Adc
Collector-Emitter Cutoff Current $V_{CE} = 5.0$ Vdc	I_{CEO}		2.0	η Adc
Emitter-Base Cutoff Current $V_{EB} = 5.0$ Vdc $V_{EB} = 6.0$ Vdc	I_{EBO}		2.0	η Adc
			10	μ Adc

ELECTRICAL CHARACTERISTICS (con't)

Characteristics	Symbol	Min.	Max.	Unit
ON CHARACTERISTICS (3)				
Forward-Current Transfer Ratio I _C = 1.0 μA _{dc} , V _{CE} = 5.0 V _{dc} I _C = 10 μA _{dc} , V _{CE} = 5.0 V _{dc} I _C = 100 μA _{dc} , V _{CE} = 5.0 V _{dc} I _C = 500 μA _{dc} , V _{CE} = 5.0 V _{dc} I _C = 1.0 mA _{dc} , V _{CE} = 5.0 V _{dc} I _C = 10 mA _{dc} , V _{CE} = 5.0 V _{dc}	h _{FE}	45 200 225 250 250 225	500 675 800 800	
Collector-Emitter Saturation Voltage I _C = 1.0 mA _{dc} , I _B = 100 μA _{dc}	V _{CE(sat)}		0.3	V _{dc}
Base-Emitter Voltage V _{CE} = 5.0 V _{dc} , I _C = 100 μA _{dc}	V _{BE}	0.5	0.7	V _{dc}

DYNAMIC CHARACTERISTICS

Forward Current Transfer Ratio I _C = 50 μA _{dc} , V _{CE} = 5.0 V _{dc} , f = 5.0 MHz I _C = 500 μA _{dc} , V _{CE} = 5.0 V _{dc} , f = 30 MHz	h _{fe}	3.0 2.0	7.0	
Open Circuit Output Admittance I _C = 1.0 mA _{dc} , V _{CE} = 5.0 V _{dc} , f = 1.0 kHz	h _{oe}		40	μmhos
Open Circuit Reverse-Voltage Transfer Ratio I _C = 1.0 mA _{dc} , V _{CE} = 5.0 V _{dc} , f = 1.0 kHz	h _{re}		8.0x10 ⁻⁴	
Input Impedance I _C = 1.0 mA _{dc} , V _{CE} = 5.0 V _{dc} , f = 1.0 kHz	h _{ie}	3.5	24	kΩ
Small-Signal Short-Circuit Forward Current Transfer Ratio I _C = 1.0 mA _{dc} , V _{CE} = 5.0 V _{dc} , f = 1.0 kHz	h _{fe}	250	900	
Output Capacitance V _{CB} = 5.0 V _{dc} , I _E = 0, 100 kHz ≤ f ≤ 1.0 MHz	C _{obo}		5.0	pF
Input Capacitance V _{EB} = 0.5 V _{dc} , I _C = 0, 100 kHz ≤ f ≤ 1.0 MHz	C _{ibo}		6.0	pF

(3) Pulse Test: Pulse Width = 300μs, Duty Cycle ≤ 2.0%.